

Customer Quote 

Receiving Customer Order 

Contract Review 

Enter order in MRP System 

Engineering 

The cam-tool generation 

Part 1. Before the Production

Raw Material Releasing

```
graph TD; A[Raw Material Releasing] --> B[Exposure of Circuit Pattern]; A --> C[Etching]; A --> D[Drilling]; A --> E[Copper Plating]; A --> F[Coverlay Application]; A --> G[Coverlay Lamination]; A --> H[Stiffener Application]; A --> I[Mounting]; A --> J[Testing];
```

Exposure of Circuit Pattern

Etching

Drilling

Copper Plating

Coverlay Application

Coverlay Lamination

Stiffener Application

Mounting

Testing

PCB Fabrication

```
graph TD; A[PCB Fabrication] --- B[The Follow-up]; B --- C[Electrical Test]; C --- D[Scoring (IF REQD)]; D --- E[Fabrication]; E --- F[Final Cleaning]; F --- G[Final Visual Inspection]; G --- H[QC And FAI Reporting]; H --- I[Packaging]; I --- J[Invoicing]; J --- K[Shipping];
```

The Follow-up

Electrical Test

Scoring (IF REQD)

Fabrication

Final Cleaning

Final Visual Inspection

QC And FAI Reporting

Packaging

Invoicing

Shipping